

L Number	Hits	Search Text	DB	Time stamp
1	0	power with chip same cob and (silicon adj nitride or SiN) and encapsul\$	USPAT	2004/07/16 14:37
2	0	power with chip same cob and (silicon adj nitride or SiN) and encapsul\$	USPAT	2004/07/16 14:36
3	0	power with chip and (silicon adj nitride or SiN) and encapsul\$	USPAT	2004/07/16 14:36
4	0	power with chip same cob and (silicon adj nitride or SiN) and encapsulat\$	USPAT	2004/07/16 14:37
5	0	power with chip same cob and (silicon adj nitride or SiN) and encapsulat\$	USPAT	2004/07/16 14:38
6	234	power with chip and (silicon adj nitride or SiN) and encapsulat\$	USPAT	2004/07/16 14:43
7	11	power adj chip and (silicon adj nitride or SiN) and encapsulat\$	USPAT	2004/07/16 14:44
8	108	power adj chip and encapsulat\$	USPAT	2004/07/16 14:44
9	7	power adj chip same encapsulat\$	USPAT	2004/07/16 14:45
10	0	p-cob same encapsulat\$	USPAT	2004/07/16 14:45
11	0	"p-cob" same encapsulat\$	USPAT	2004/07/16 14:45
12	0	"chip on board" same encapsulat\$	USPAT	2004/07/16 14:46
13	0	(chip adj on adj board) same encapsulat\$	USPAT	2004/07/16 14:46
14	0	(chip adj on adj board) same encaps\$	USPAT	2004/07/16 14:46
15	0	(chip adj on adj board) same resin	USPAT	2004/07/16 14:47
16	135	COB same resin	USPAT	2004/07/16 14:51
17	44	COB same resin and power	USPAT	2004/07/16 14:51